

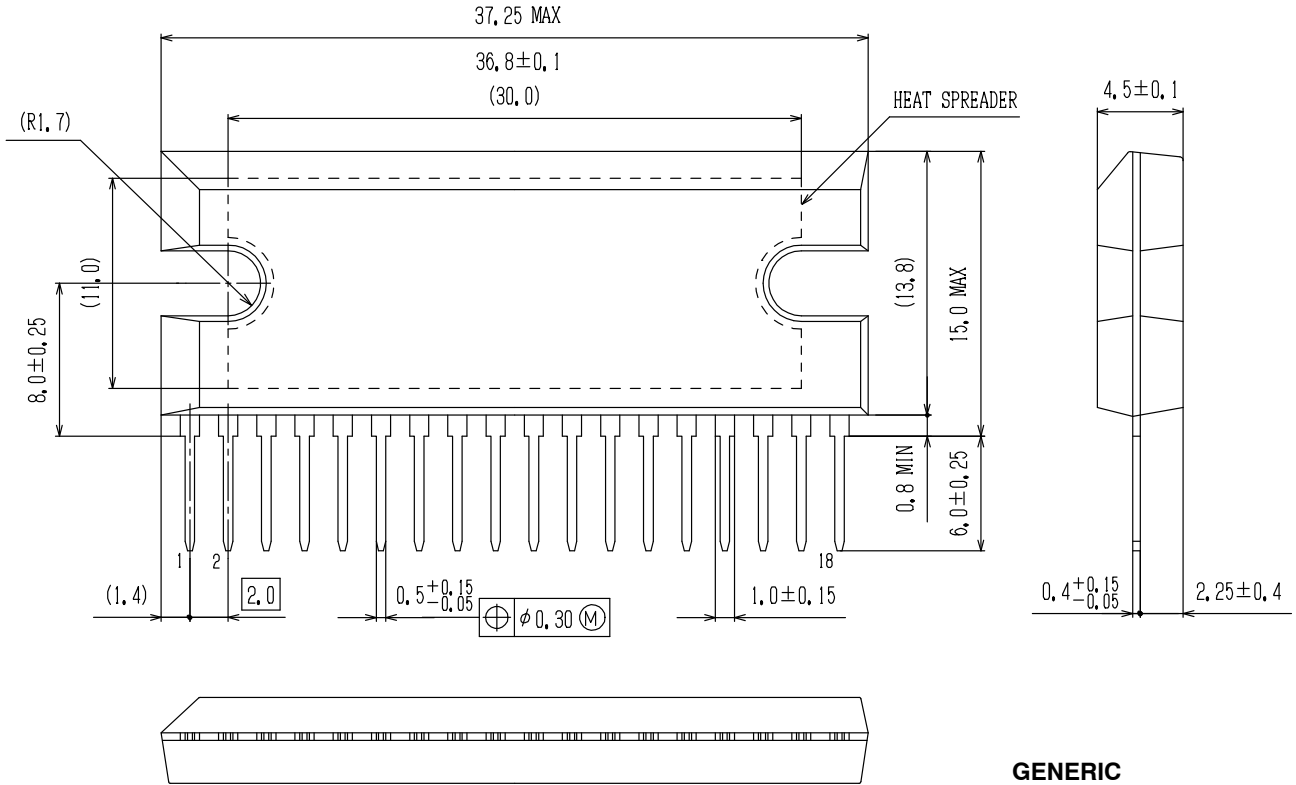
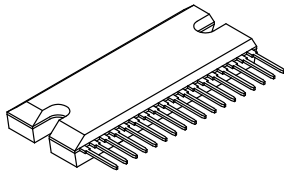
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

ON Semiconductor®

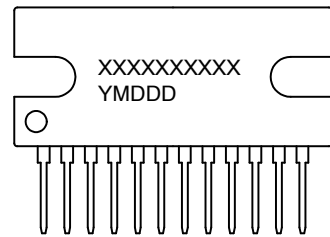


SIP18 36.8x13.8 / SIP18H
CASE 127AS
ISSUE A

DATE 23 OCT 2013



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
 Y = Year
 M = Month
 DDD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

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NEW STANDARD:		
DESCRIPTION:	SIP18 / SIP18H 36.8X13.8	PAGE 1 OF 2

